

Wiring, Printed - Component


COMPANY

TECHNO SERVICE S A
 Ul Siedlicka 6
 Gdansk, 80-222 Poland

E203339

Type	Cond Width		Cond Thk mic	SS/ DS/ DSO	Max Area Diam mm	Report Date After 2022-01-01	Surface Mount Technology	Assembly Process Temp °C	Solder Process Cycles	Max			Meets UL796 Class	C T I	
	Min	Edge								Solder Limits °C	Oper Temp °C	Flame			
	mm	mm													
Multilayer printed wiring boards															
M	0.2	0.2	16.5 Int:33	DS	25.4	No	-	-	-	260	5	125	V-0	All	*
M1	0.1	0.25	16.5 Int:105	DS	25.4	No	-	-	-	280	5	130	V-0	All	*
M2	0.1	0.25	16.5 Int:70	DS	25.4	No	-	-	-	280	5	130	V-0	All	3
Single layer printed wiring boards															
D	0.2	0.2	16.5	DS	25.4	No	-	-	-	260	5	125	V-0	All	*
D1	0.10	0.25	16.5	DS	25.5	No	-	-	-	280	5	130	V-0	All	*

* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or trademark  or file number and type designation. May be followed by a suffix to denote factory identification or flammability classification..

Last Updated on 2022-06-18

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